

Dear Colleagues and Students,

We are pleased to invite you to submit your papers to PLM'17. Please consider to contribute to and/or forward to the appropriate groups the following Call for Papers (CfP):

PLM'17 - IFIP 14th International Conference on Product Lifecycle Management

<http://www.plm-conference.org>

9-12 July, Seville, Spain

Important Dates:

Abstract Submission: December 12, 2016

Full Paper Submission: February 15, 2017

Notification of Acceptance: March 30, 2017

Camera Ready due: May 15, 2017

Author Early Bird Registration: June 4, 2017

Papers dealing with theoretical, conceptual, applicative or survey contributions are welcome. All submissions will be reviewed on the basis of relevance, originality, importance and clarity. Topics of interest include the following areas (but not limited to):

- Augmented and virtual reality
- 3D Printing and Additive Manufacturing
- PLM & Business Process Management
- Industry of the future & Industry 4.0
- Internet of Things (IoT)
- PLM tools: PDM, CAD/CAM, ERP, CAPP...
- Interoperability and systems Integration
- Cyber-Physical Systems (CPS)
- Product/Service/Systems (PSS)
- Building Information Modelling (BIM)
- Information Lifecycle Management (ILM)
- Smart/intelligent/Meta/Hybrid products
- Simulation Lifecycle Management (SLM)
- Model-based design & simulation
- PLM and Computer Aided Software Engineering (CASE)
- Ontologies, languages & standards
- Knowledge sharing, re-use and preservation
- Case-based Reasoning (CBR) applications
- Collaborative development architectures
- Configuration & change engineering / management
- PLM educational and training approach
- Traceability and performance
- Lifecycle Cyber-Security issues
- Agile PLM - Social networks impact
- Cloud Computing and Mobile PLM
- Metrics, standards and regulation
- Big Data analytics and Business Intelligence
- Infrastructure/implementation process
- Lifecycle assessment and sustainability
- Supply Chain and Value Chain Integration

Proceedings and Journals

Papers selected for presentation will appear in a Springer Advanced ICT series book (instructions: <https://www.springer.com/gp/authors-editors/book-authors-editors/book-manuscript-guidelines>).

Selected extended papers from the conference will be proposed for publication in the IJPLM International Journal of Product Lifecycle Management (official journal of IFIP WG5.1) and other indexed journals.

Conference Awards

IFIP Awards will be given to the Best Conference Paper and to the Best Doctoral Research Work.

Industrial Sessions and Visit

A full day will be dedicated to industrial sessions and panels. A visit to an aerospace partner site will be organized.

IFIP PhD Workshop

PhD students will be part of the IFIP PhD network, present their thesis work in the PhD Workshop and have feedback from experts and supervisors.

Rich Social Program

Discover Seville culture through visits to local famous historical sites, museums and through a special outdoors program!

Welcome to Seville!

Contact: plm.conference.2017@gmail.com

On behalf of the Organisation Committee,

José Ríos and Carmelo del Valle